

# **20V N-Channel MOSFET**

#### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> TYP	Ι <sub>D</sub>	
20V	250mΩ@4.5V	0.754	
200	350mΩ@2.5V	0.75A	

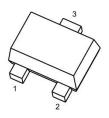
#### Feature

- Surface Mount Package
- N-Channel Switch with Low R<sub>DS</sub>(on)
- Operated at Low Logic Level Gate Drive
- ESD Protected:HBM 2KV

#### Application

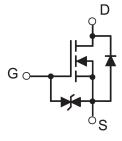
- Load/Power Switching
- Interfacing Switching
- Battery Management for Ultra Small Portable
  Electronics
- Logic Level Shift

#### Package



SOT-723

#### **Circuit diagram**





## Absolute maximum ratings (Ta=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DS</sub>	20	V
Gate-Source Voltage	V <sub>GS</sub>	±12	V
Continuous Drain Current	ID	0.75	A
Pulsed Drain Current	I <sub>DM</sub>	1.8	A
Power Dissipation	PD	0.15	W
Thermal Resistance from Junction to Ambient	R <sub>0JA</sub>	833	°C/W
Junction Temperature	TJ	150	°C
Storage Temperature	Tstg	-55~ +150	°C

### Electrical characteristics (T<sub>A</sub>=25 °C, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Static Characteristics		·	•	•	•	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> =250µA	20			V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> =16V,V <sub>GS</sub> = 0V			1	μA
Gate-body leakage current	I <sub>GSS</sub>	$V_{GS}$ =±10V, $V_{DS}$ = 0V			±10	uA
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250µA	0.35	0.65	1	V
Drain-source on-resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 0.5A		0.25	0.38	Ω
		V <sub>GS</sub> =2.5V, I <sub>D</sub> = 0.5A		0.35	0.45	
		V <sub>GS</sub> =1.8V, I <sub>D</sub> = 0.5A		0.4	0.8	
Dynamic characteristics			•	•	•	•
Input Capacitance	Ciss			79	120	pF
Output Capacitance	Coss	] V <sub>DS</sub> =16V,V <sub>GS</sub> =0V, ] f=1MHz		13	20	
Reverse Transfer Capacitance	C <sub>rss</sub>			9	15	
Switching Characteristics	•		•	•	•	•
Turn-on delay time	t <sub>d(on)</sub>			6.7		ns
Turn-on rise time	tr	− V <sub>GS</sub> =4.5V,V <sub>DS</sub> =10V,		4.8		
Turn-off delay time	t <sub>d(off)</sub>	$I_D = 500 \text{mA}, R_{\text{GEN}} = 10 \Omega$		17.3		
Turn-off fall time	t <sub>f</sub>	1		7.4		
Source-Drain Diode characteristics				•	1	1
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> =0.5A, V <sub>GS</sub> = 0V		0.7	1.3	V

CAUTION: These devices are sensitive to electrostatic discharge; follow proper IC Handling Procedures.

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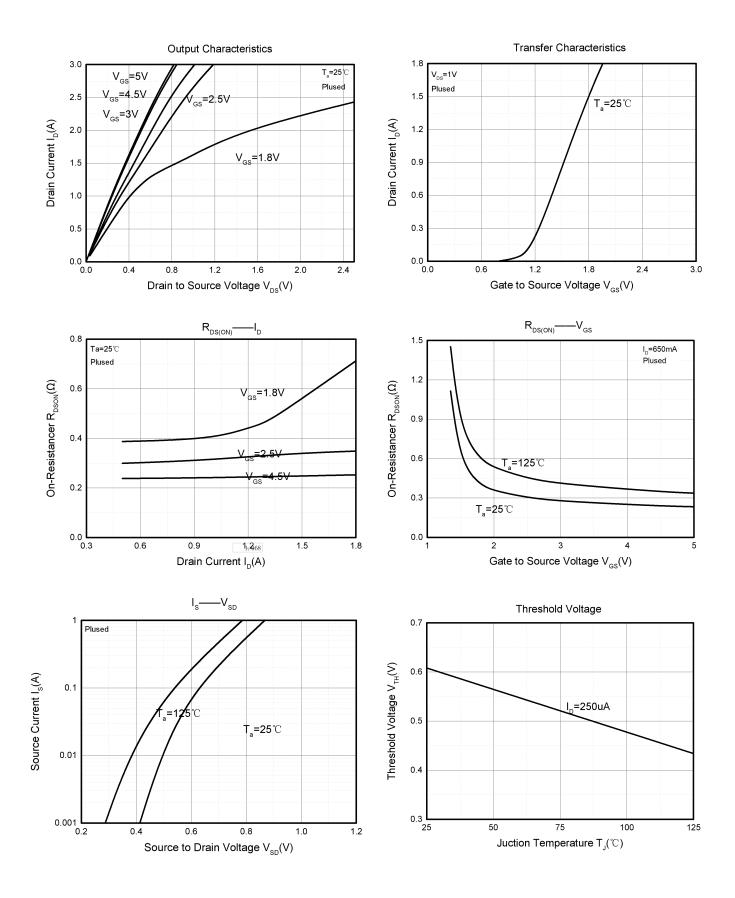
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# **Typical Characteristics**

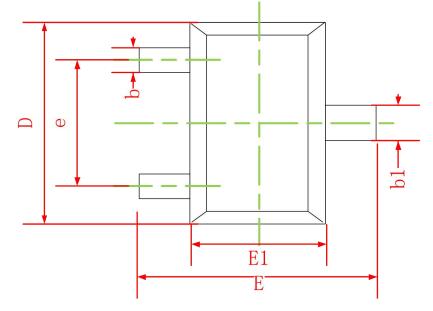


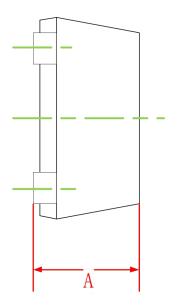
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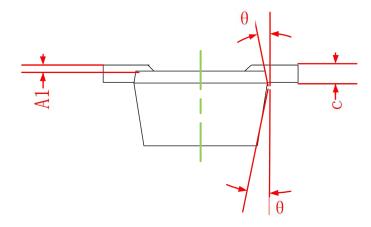


# **SOT-723 Package Information**





S2002KG



Symbol	Dimensions In Millimeters			
	Min.	Max.		
A	0.430 0.500			
A1	0.000 0.050			
b	0.170	0.270		
b1	0.270	0.370		
С	0.080	0.150		
D	1.150	.150 1.250		
E	1.150	1.250		
E1	0.750	0.850		
e	0.800TYP.			
θ	7° REF.			

